

## 11A, 650V SUPER JUNCTION MOS POWER TRANSISTOR

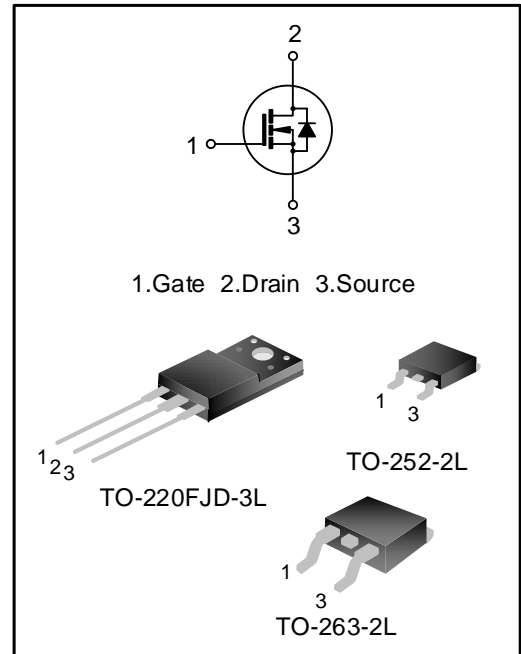
### DESCRIPTION

SVS60R340FJD(D)(S)D4 is an N-channel enhancement mode high voltage power MOSFETs produced using Silan's super junction MOS technology. It achieves low conduction loss and switching losses. It leads the design engineers to their power converters with high efficiency, high power density, and superior thermal behavior.

Furthermore, it's universal applicable, i.e., suitable for hard and soft switching topologies.

### FEATURES

- ◆ 11A, 650V,  $R_{DS(on)(typ.)}=0.28\Omega@V_{GS}=10V$
- ◆ New revolutionary high voltage technology
- ◆ Ultra low gate charge
- ◆ Periodic avalanche rated
- ◆ Extreme dv/dt rated
- ◆ High peak current capability
- ◆ 100% avalanche tested
- ◆ Pb-free lead plating
- ◆ RoHS compliant



### KEY PERFORMANCE PARAMETERS

Characteristics	Ratings	Unit
$V_{DS@T_J,max}$	650	V
$V_{GS(th)}$	2.5~4.5	V
$R_{DS(on), max.}$	0.34	$\Omega$
$I_{D,pulse}$	44	A
$Q_{g,typ.}$	20	nC

### ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVS60R340FJDD4	TO-220FJD-3L	60R340D4	Halogen free	Tube
SVS60R340DD4TR	TO-252-2L	60R340D4	Halogen free	Tape & Reel
SVS60R340SD4TR	TO-263-2L	60R340D4	Halogen free	Tape & Reel
SVS60R340SD4	TO-263-2L	60R340D4	Halogen free	Tube

**ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED,  $T_J=25^{\circ}\text{C}$ )**

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Gate-source Voltage (Static)	$V_{GS}$	--	-20	--	20	V
Gate-source Voltage (Dynamic)	$V_{GS}$	AC( $f>1\text{Hz}$ )	-30	--	30	V
Drain Current	$I_D$	$T_C=25^{\circ}\text{C}$	--	--	11	A
		$T_C=100^{\circ}\text{C}$	--	--	7.0	A
Drain Current Pulsed (Note 1)	$I_{DM}$	$T_C=25^{\circ}\text{C}$	--	--	44	A
Power Dissipation (TO-220FJD-3L) (Note 2)	$P_D$	$T_C=25^{\circ}\text{C}$	--	--	24	W
Power Dissipation (TO-252-2L) (Note 2)	$P_D$	$T_C=25^{\circ}\text{C}$	--	--	104	W
Power Dissipation (TO-263-2L) (Note 2)	$P_D$	$T_C=25^{\circ}\text{C}$	--	--	119	W
Single Pulsed Avalanche Energy	$E_{AS}$	$L=79\text{mH}$ , $V_{DD}=100\text{V}$ , $R_G=25\Omega$ , starting temperature $T_J=25^{\circ}\text{C}$	--	--	227	mJ
Single Pulsed Current	$I_{AS}$	--	--	--	2.2	A
Reverse Diode dv/dt	dv/dt	$V_{DS}=0\sim 400\text{V}$ , $I_{SD}\leq I_S$ , $T_J=25^{\circ}\text{C}$	--	--	15	V/ns
MOS dv/dt Ruggedness	dv/dt	$V_{DS}=0\sim 480\text{V}$	--	--	50	V/ns
Operation Junction Temperature Range	$T_J$	--	-55	--	150	$^{\circ}\text{C}$
Storage Temperature Range	$T_{stg}$	--	-55	--	150	$^{\circ}\text{C}$
Continuous Diode Forward Current	$I_S$	$T_C=25^{\circ}\text{C}$ , integral reverse P-N junction diode in the MOSFET	--	--	11	A
Diode Pulse Current	$I_{S,pulse}$		--	--	44	A
Maximum Diode Commutation Speed	di/dt	$V_{DS}=0\sim 400\text{V}$ , $I_{SD}\leq I_S$ , $T_J=25^{\circ}\text{C}$	--	--	500	A/ $\mu\text{s}$

## THERMAL CHARACTERISTICS

Table1. TO-220FJD-3L (SVS60R340FJDD4)

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Thermal Resistance, Junction-case, Bottom	$R_{\theta JC}$	--	--	--	5.2	°C/W
Thermal Resistance, Junction-ambient	$R_{\theta JA}$	--	--	--	62.5	°C/W
Soldering Temperature (in line)	$T_{sold}$	15 <sup>+2</sup> <sub>-0</sub> sec, 1time	--	--	260	°C

Table 2. TO-252-2L (SVS60R340DD4)

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Thermal Resistance, Junction-case, Bottom	$R_{\theta JC}$	--	--	--	1.2	°C/W
Thermal Resistance, Junction-ambient	$R_{\theta JA}$	--	--	--	62.0	°C/W
Soldering Temperature(SMD)	$T_{sold}$	Reflow soldering:10±1sec, 3times	--	--	260	°C

Table 3. TO-263-2L (SVS60R340SD4)

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Thermal Resistance, Junction-case, Bottom	$R_{\theta JC}$	--	--	--	1.05	°C/W
Thermal Resistance, Junction-ambient	$R_{\theta JA}$	--	--	--	62.5	°C/W
Soldering Temperature(SMD)	$T_{sold}$	Reflow soldering:10±1sec, 3times	--	--	260	°C

## ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED, $T_J=25^{\circ}\text{C}$ )

### Static characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Drain-source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	600	--	--	V
Drain-source Leakage Current	$I_{DSS}$	$V_{DS}=600V, V_{GS}=0V, T_J=25^{\circ}\text{C}$	--	--	1.0	$\mu A$
		$V_{DS}=600V, V_{GS}=0V, T_J=125^{\circ}\text{C}$	--	0.5	--	
Gate-source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	--	--	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	2.5	--	4.5	V
Static Drain-source On State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=5.5A, T_J=25^{\circ}\text{C}$	--	0.28	0.34	$\Omega$
		$V_{GS}=10V, I_D=5.5A, T_J=150^{\circ}\text{C}$	--	0.65	--	
Gate Resistance	$R_G$	$f=1\text{MHz}$	--	3.0	--	$\Omega$

### Dynamic characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Input Capacitance	$C_{iss}$	$f=1\text{MHz}, V_{GS}=0V, V_{DS}=100V$	--	674	--	pF
Output Capacitance	$C_{oss}$		--	35	--	
Reverse Transfer Capacitance	$C_{rss}$		--	1.9	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=300V, V_{GS}=10V, R_G=24\Omega, I_D=11A$ (Notes 3, 4)	--	15	--	ns
Turn-on Rise Time	$t_r$		--	38	--	
Turn-off Delay Time	$t_{d(off)}$		--	45	--	
Turn-off Fall Time	$t_f$		--	27	--	
Total Gate Charge	$Q_g$	$V_{DD}=480V, V_{GS}=10V, I_D=11A$ (Notes 3, 4)	--	20	--	nC
Gate-source Charge	$Q_{gs}$		--	5.9	--	
Gate-drain Charge	$Q_{gd}$		--	11	--	
Gate-plateau Voltage	$V_{plateau}$		--	7.4	--	V

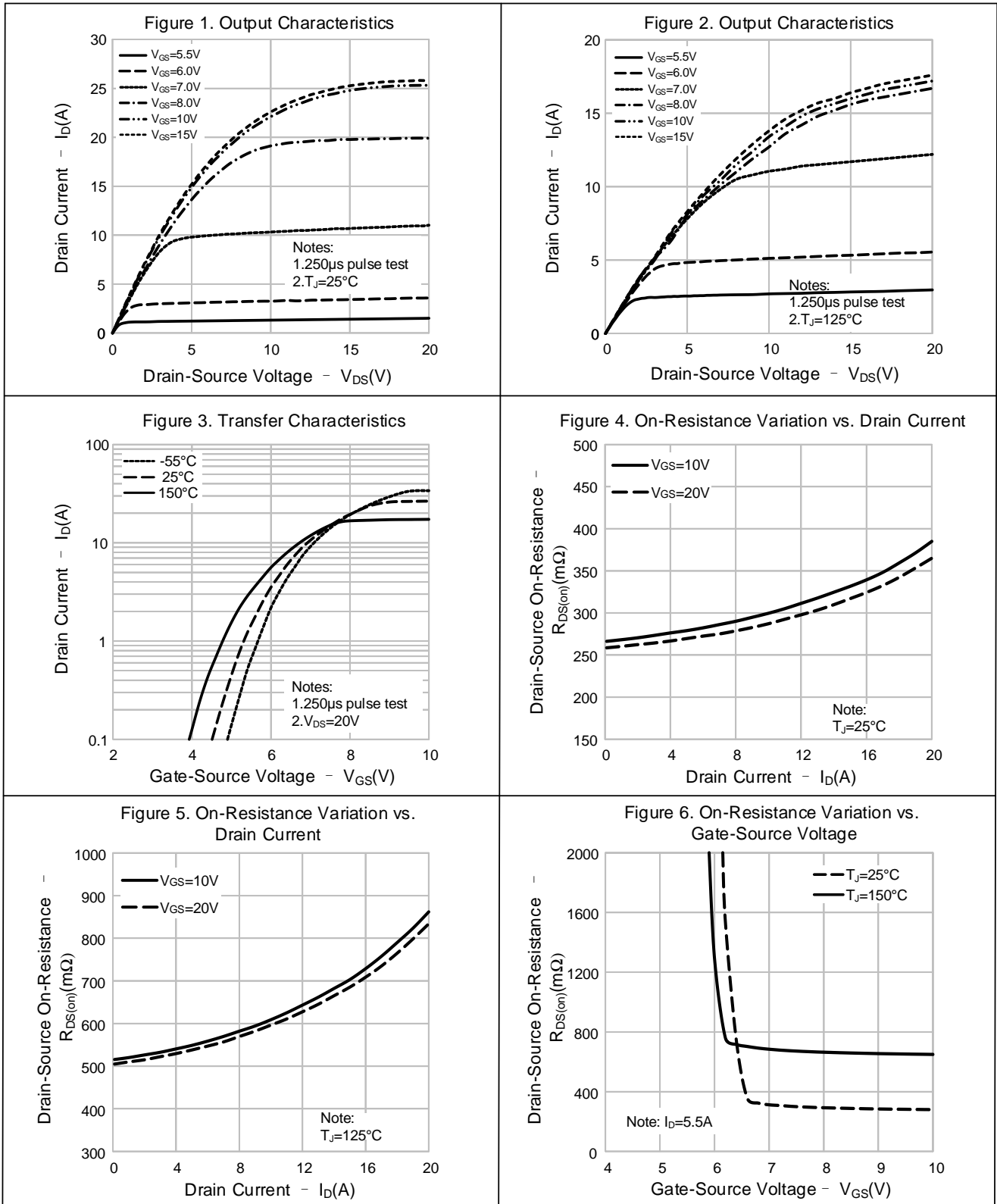
### Reverse diode characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Diode Forward Voltage	$V_{SD}$	$I_S=11A, V_{GS}=0V$	--	--	1.4	V
Reverse Recovery Time	$T_{rr}$	$I_S=11A, V_{GS}=0V, V_R=50V, dI_F/dt=100A/\mu s$ (Note 3)	--	282	--	ns
Reverse Recovery Charge	$Q_{rr}$		--	3.4	--	$\mu C$
Reverse Recovery Peak Current	$I_{rrm}$		--	23	--	A

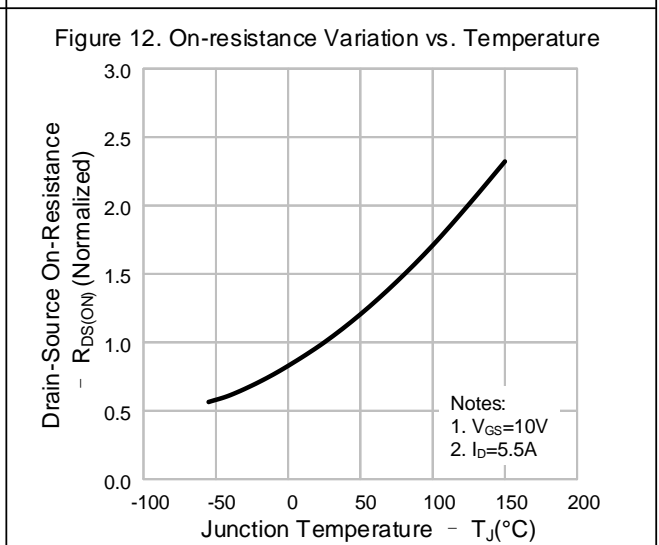
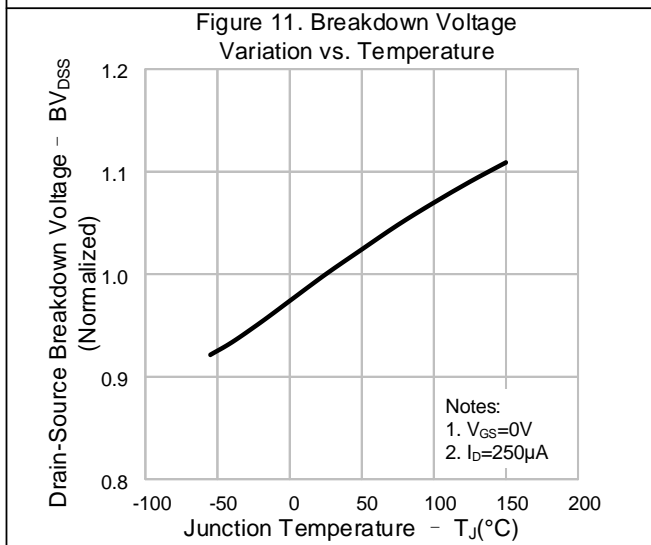
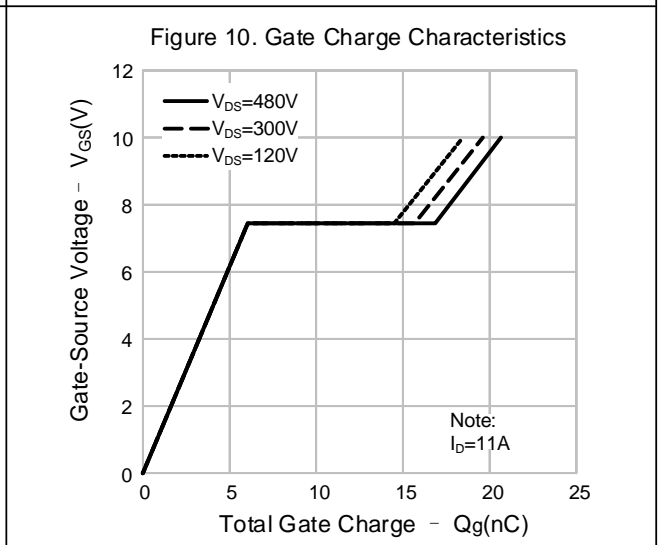
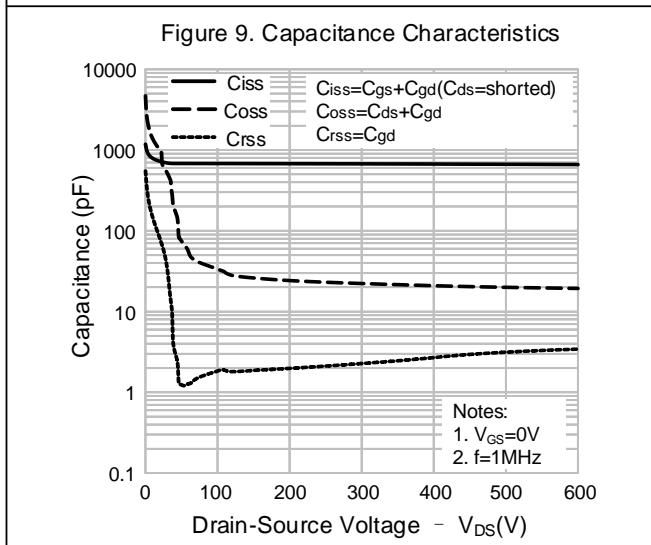
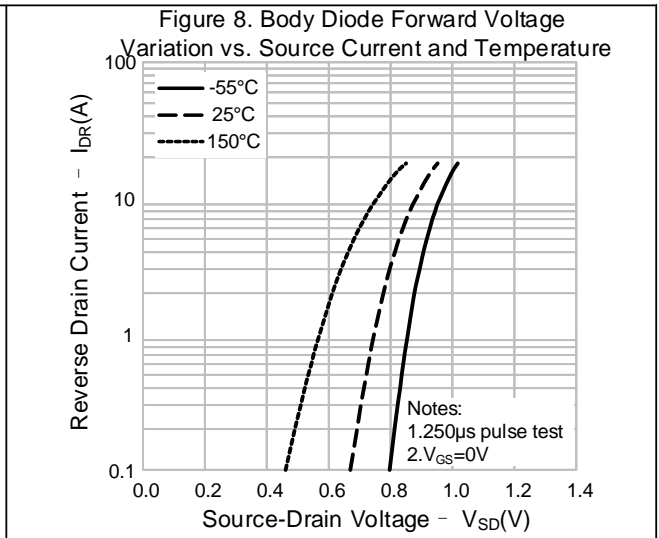
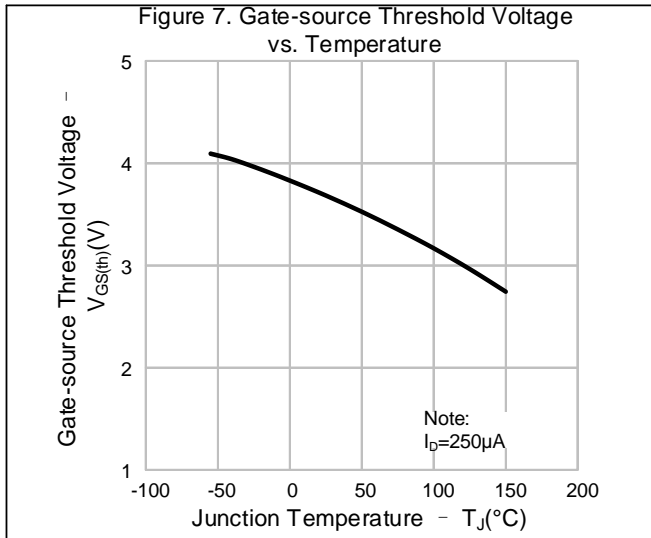
#### Notes:

1. Pulse time  $5\mu s$ ;
2. The dissipation power will change with temperature, derating above  $25^{\circ}\text{C}$ :  
 $0.19\text{W}/^{\circ}\text{C}$  (TO-220FJD-3L)/ $0.83\text{W}/^{\circ}\text{C}$  (TO-252-2L)/ $0.95\text{W}/^{\circ}\text{C}$  (TO-263-2L);
3. Pulse Test: Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ ;
4. Essentially independent of operating temperature.

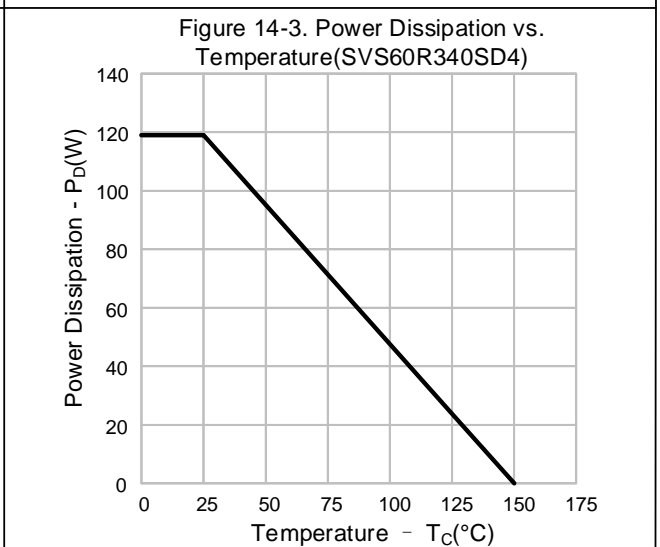
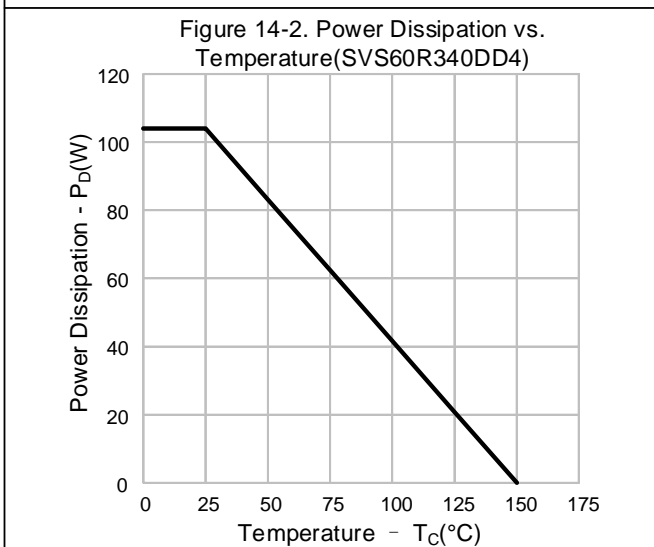
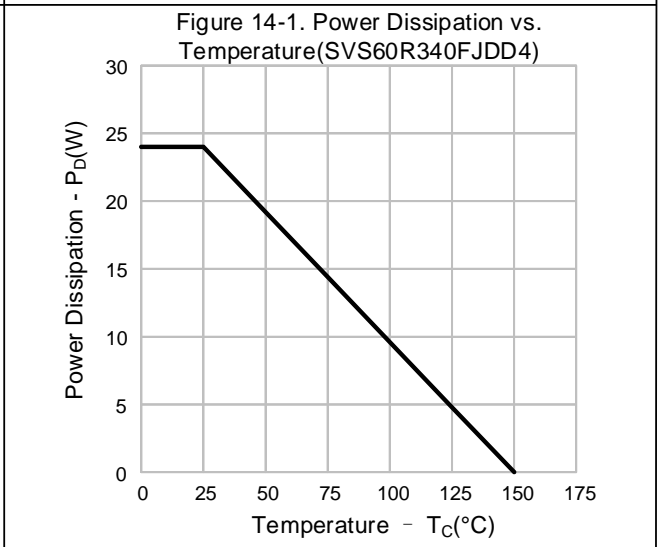
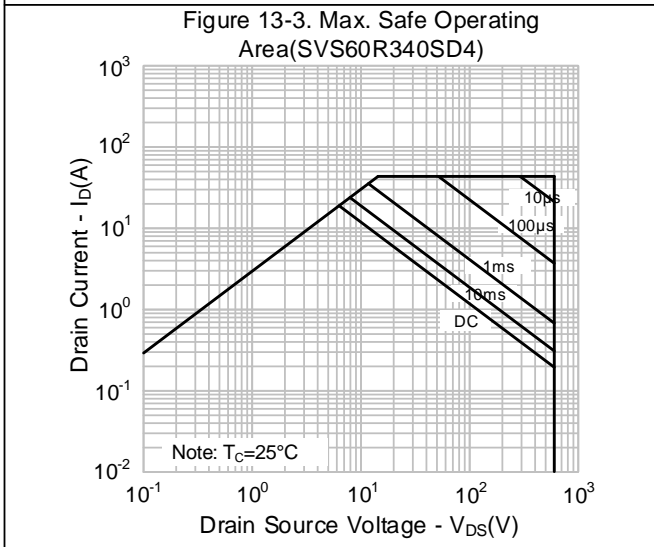
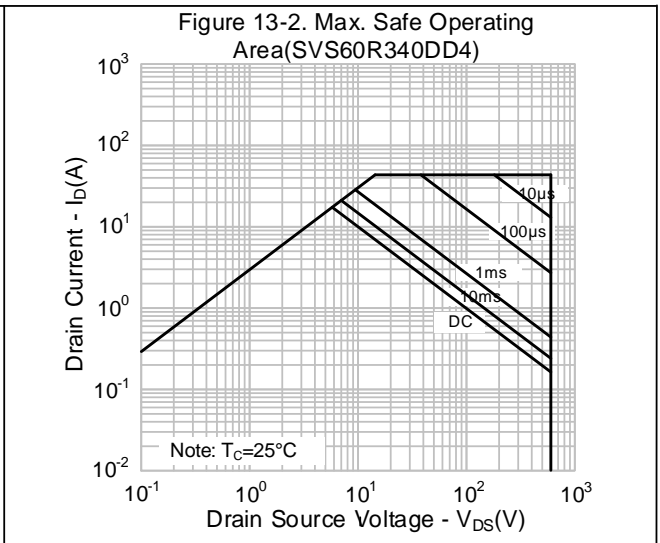
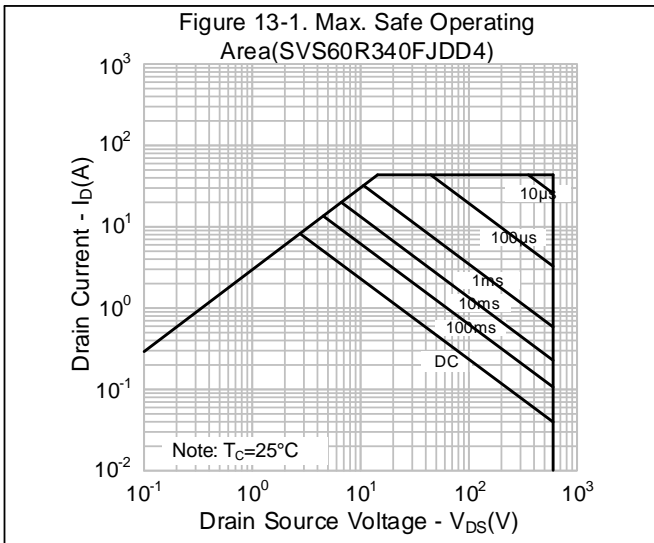
**TYPICAL CHARACTERISTICS**



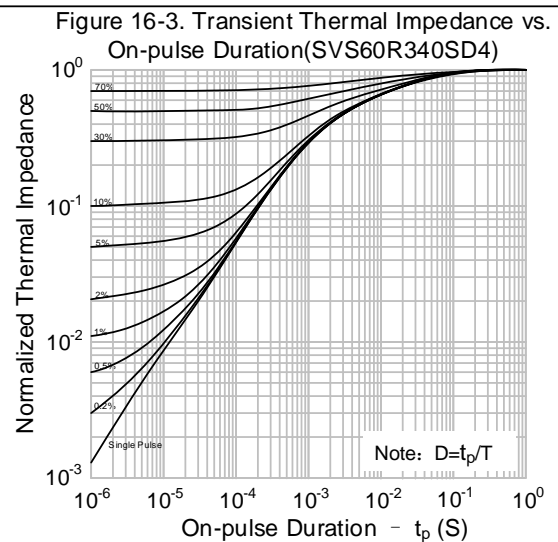
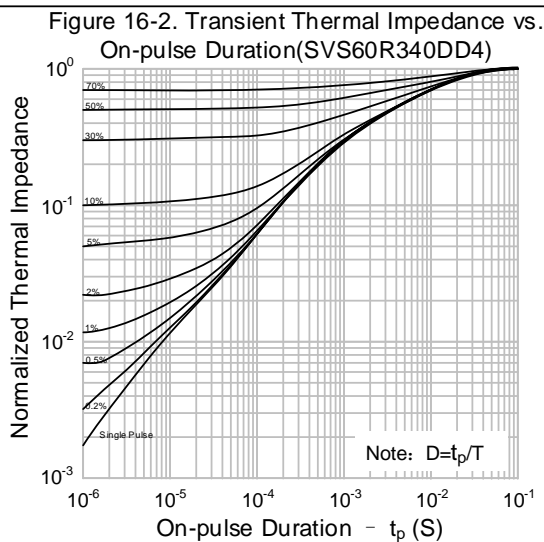
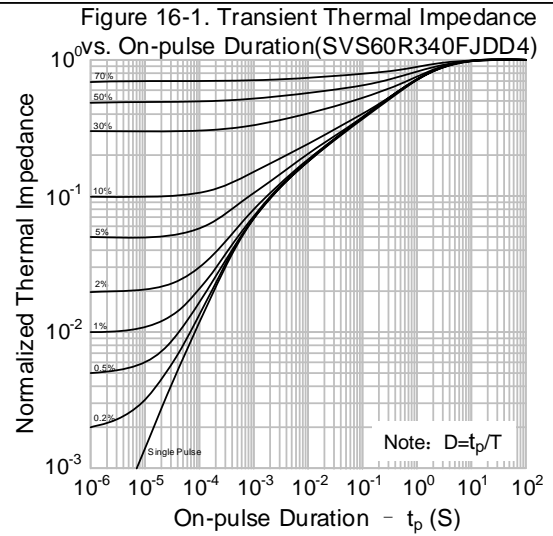
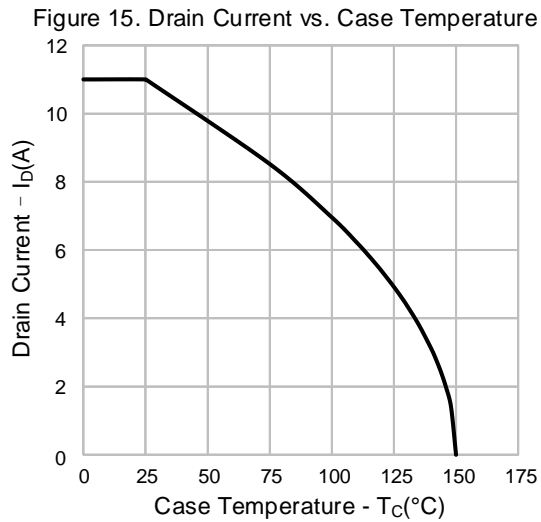
**TYPICAL CHARACTERISTICS (CONTINUED)**



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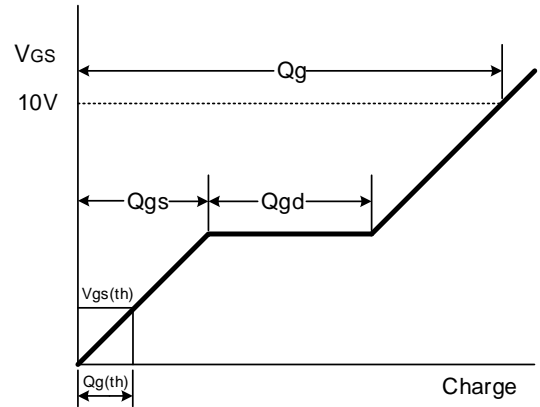
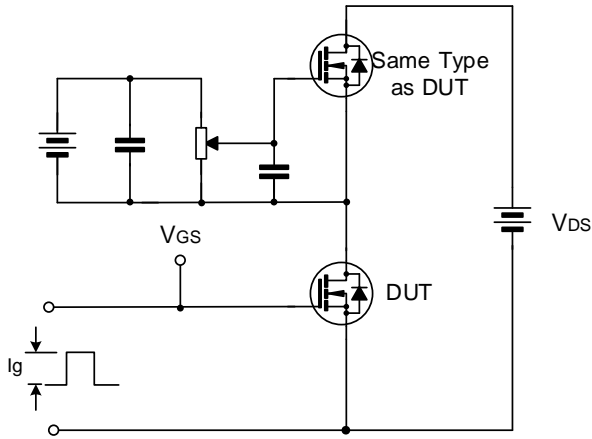
**TYPICAL CHARACTERISTICS (CONTINUED)**



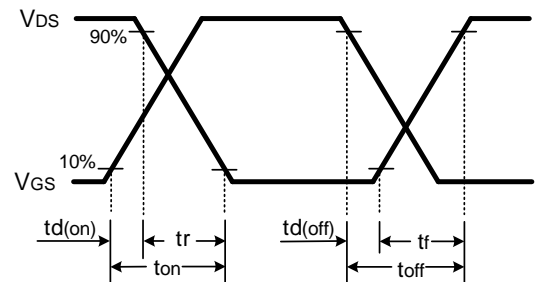
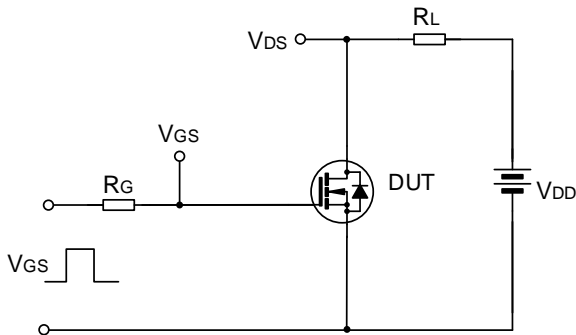


**TYPICAL TEST CIRCUIT**

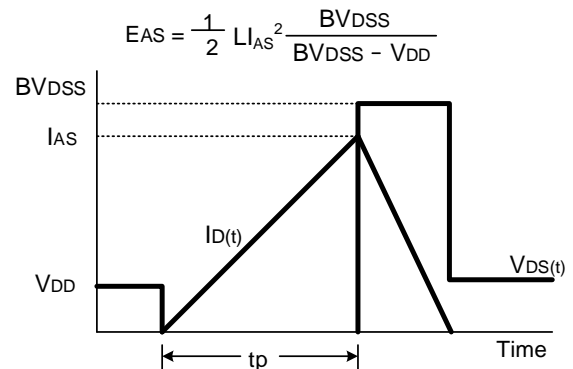
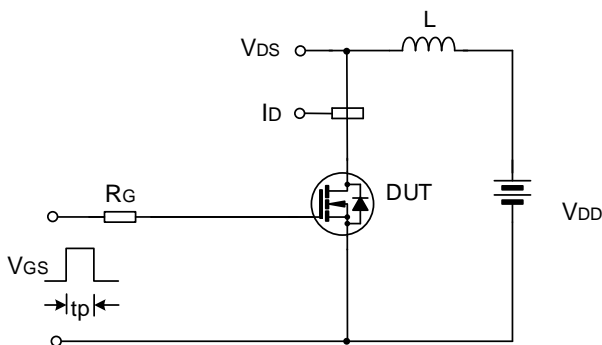
Gate Charge Test Circuit & Waveform



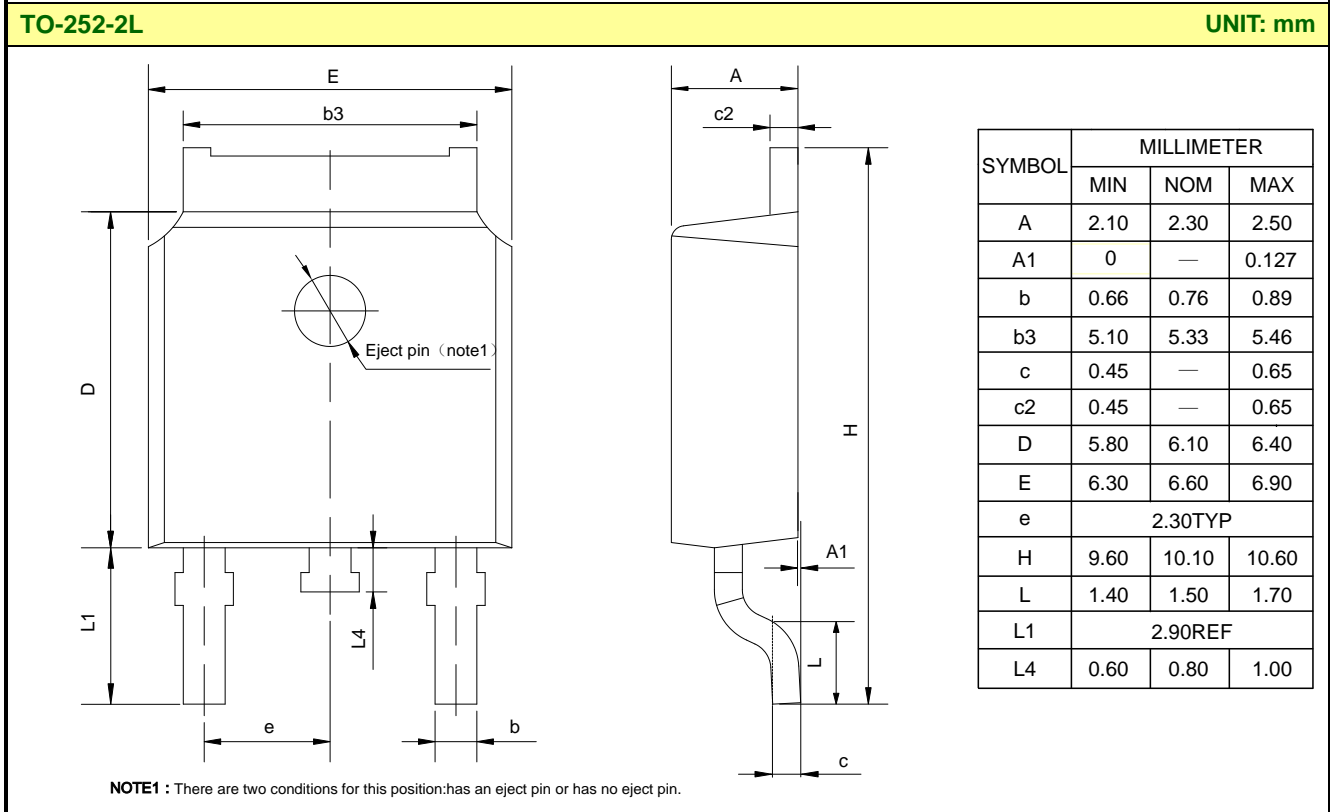
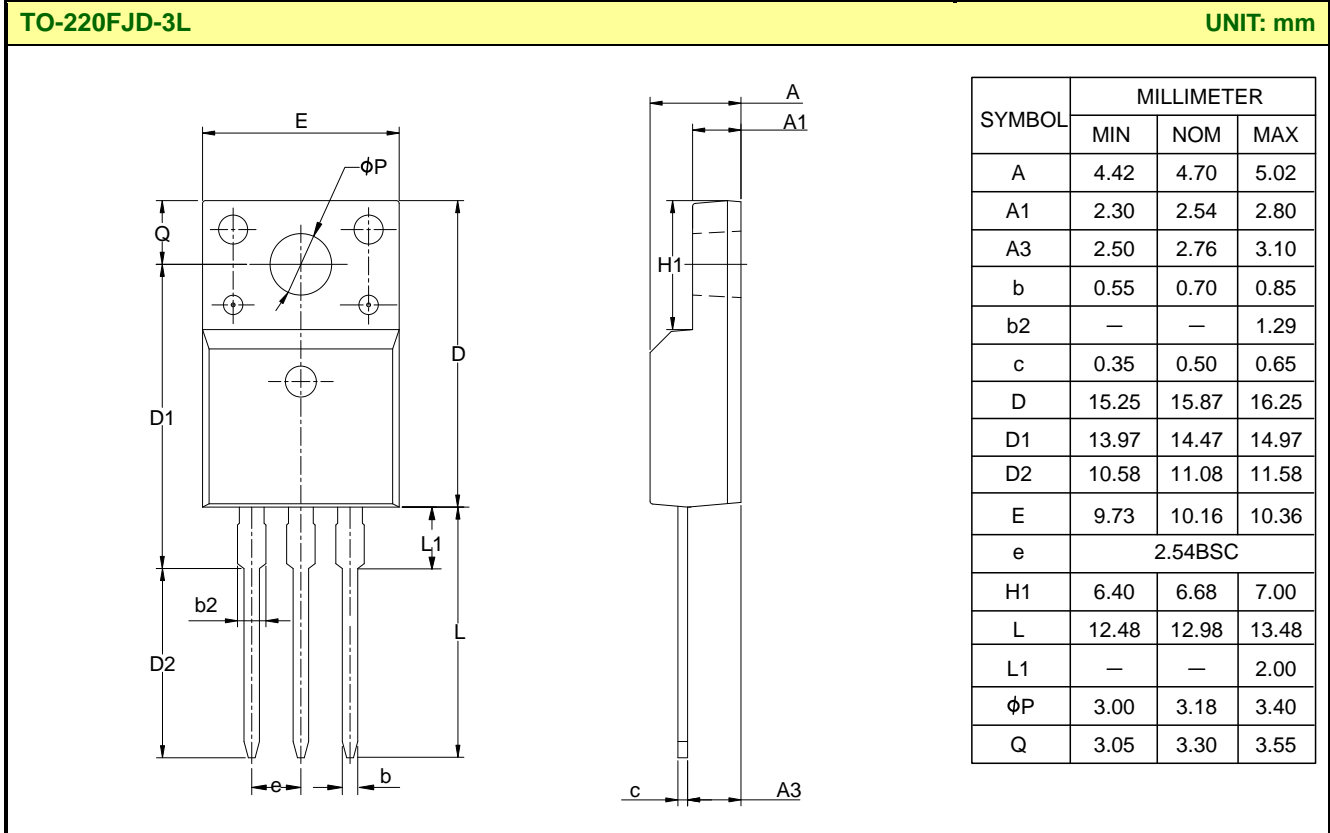
Resistive Switching Test Circuit & Waveform



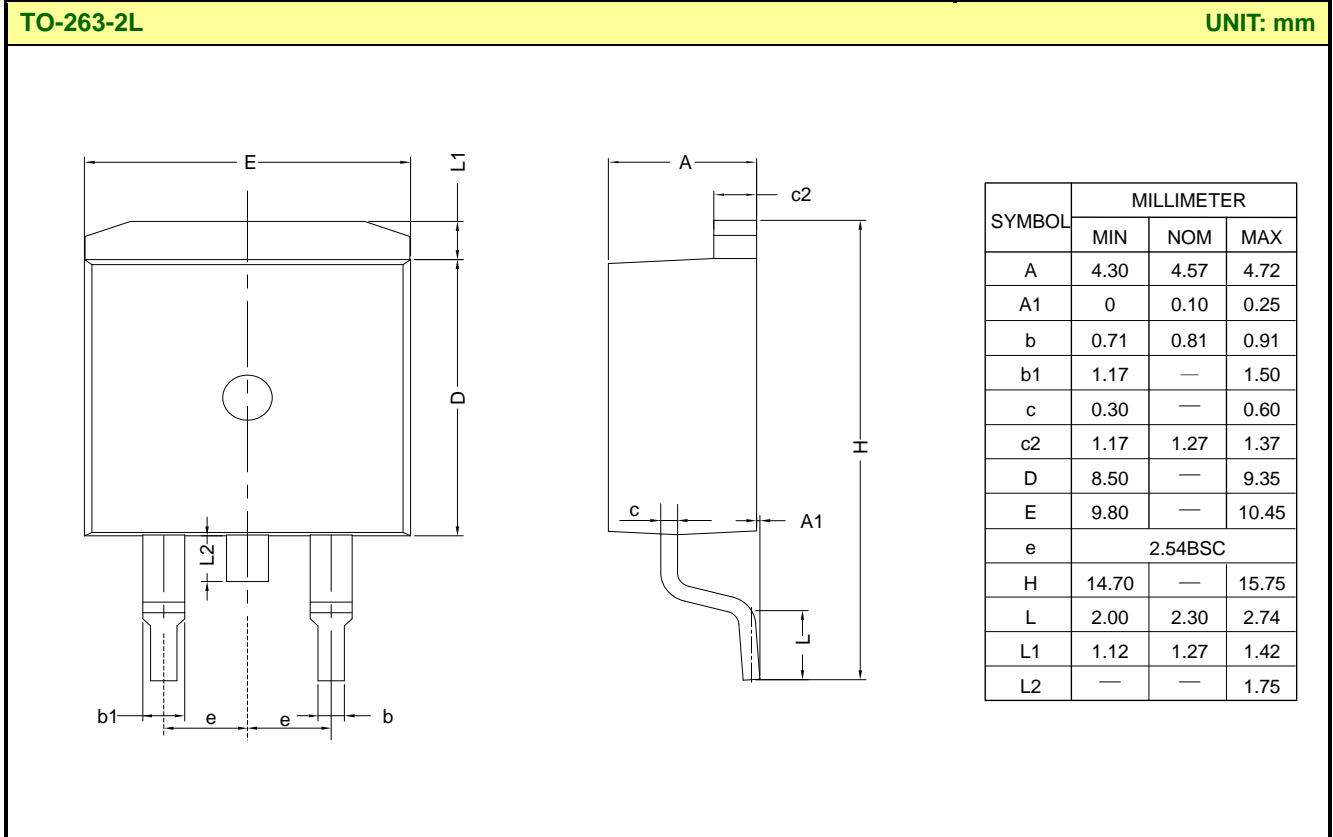
Unclamped Inductive Switching Test Circuit & Waveform



**PACKAGE OUTLINE**



**PACKAGE OUTLINE (CONTINUED)**



**MOS DEVICES OPERATE NOTES:**

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

**Important notice :**

1. Silan reserves the right to make changes of this instruction without notice.
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9. Website: <http://www.silan.com.cn>



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Rev.: 1.1

Revision History:

1. Add SVS60R340SD4(TO-263-2L) package
  2. Update the curve
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Rev.: 1.0

Revision History:

1. First release
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